

SURFACE MOUNT FAST SWITCHING DIODE ARRAY

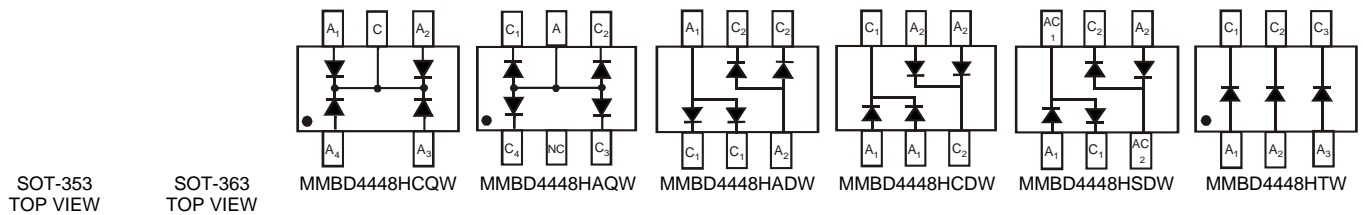
Features

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- **Lead Free/RoHS Compliant (Note 1)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **"Green" Device (Notes 2 and 3)**

Mechanical Data

- Case: SOT-353 or SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Orientation: See Diagrams Below
- Weight: 0.006 grams (approximate)

SOT-353/SOT-363

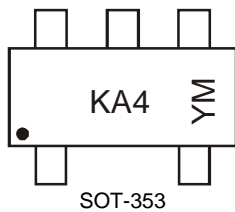


Ordering Information (Note 4)

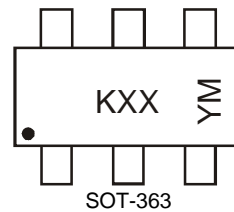
Part Number	Case	Packaging
MMBD4448HADW-7-F	SOT-363	3000/Tape & Reel
MMBD4448HAQW-7-F	SOT-363	3000/Tape & Reel
MMBD4448HCDW-7-F	SOT-363	3000/Tape & Reel
MMBD4448HCQW-7-F	SOT-353	3000/Tape & Reel
MMBD4448HSDW-7-F	SOT-363	3000/Tape & Reel
MMBD4448HTW-7-F	SOT-363	3000/Tape & Reel

- Notes:
1. No purposefully added lead.
 2. Diodes Inc.'s "Green" policy can be found on our website at <http://www.diodes.com>.
 3. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
 4. For packaging details, go to our website at <http://www.diodes.com>.

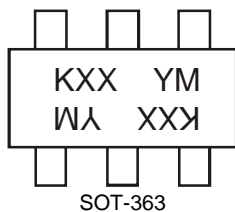
Marking Information



KA4 = Product Type Marking Code,
KA4 = MMBD4448HCQW
YM = Date Code Marking
Y = Year (ex: N = 2002)
M = Month (ex: 9 = September)



KXX = Product Type Marking Code,
ex. KA5 = MMBD4448HAQW
KAA = MMBD4448HTW
YM = Date Code Marking
Y = Year (ex: N = 2002)
M = Month (ex: 9 = September)



KXX = Product Type Marking Code,
ex. KA6 = MMBD4448HADW
KA7 = MMBD4448HCDW
KAB = MMBD4448HSDW
YM = Date Code Marking
Y = Year (ex: N = 2002)
M = Month (ex: 9 = September)

Date Code Key

Year	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014	2015
Code	L	M	N	P	R	S	T	U	V	W	X	Y	Z	A	B	C

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V	
Peak Repetitive Reverse Voltage	V _{RRM}	80	V	
Working Peak Reverse Voltage	V _{RWM}			
DC Blocking Voltage	V _R			
RMS Reverse Voltage	V _{R(RMS)}	57	V	
Forward Continuous Current (Note 5)	I _{FM}	500	mA	
Average Rectified Output Current (Note 5)	I _O	250	mA	
Non-Repetitive Peak Forward Surge Current	I _{FSM}	@ t = 1.0μs	4.0	A
		@ t = 1.0s	1.0	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	80	—	V	I _R = 100μA
Forward Voltage	V _F	0.62	0.72	V	I _F = 5.0mA
		—	0.855		I _F = 10mA
		—	1.0		I _F = 100mA
		—	1.25		I _F = 150mA
Reverse Current (Note 6)	I _R	—	100	nA	V _R = 70V
		—	50	μA	V _R = 75V, T _J = 150°C
		—	30	μA	V _R = 25V, T _J = 150°C
		—	25	nA	V _R = 20V
Total Capacitance	C _T	—	3.5	pF	V _R = 6V, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	4.0	ns	V _R = 6V, I _F = 5mA

- Notes: 5. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com>.
6. Short duration pulse test used to minimize self-heating effect.

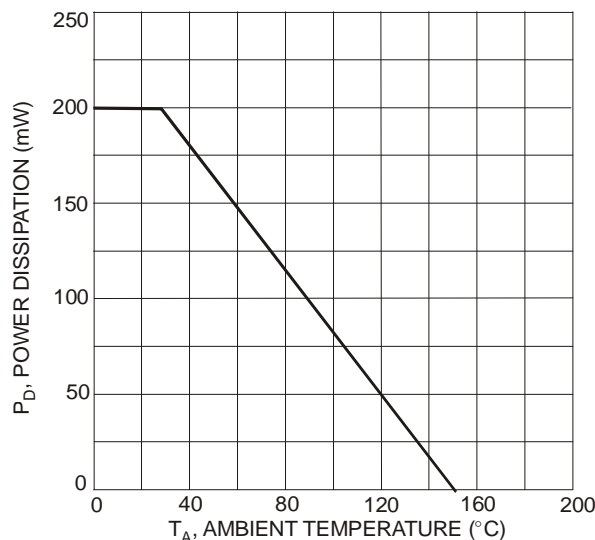


Fig. 1 Power Derating Curve, Total Package (Note 5)

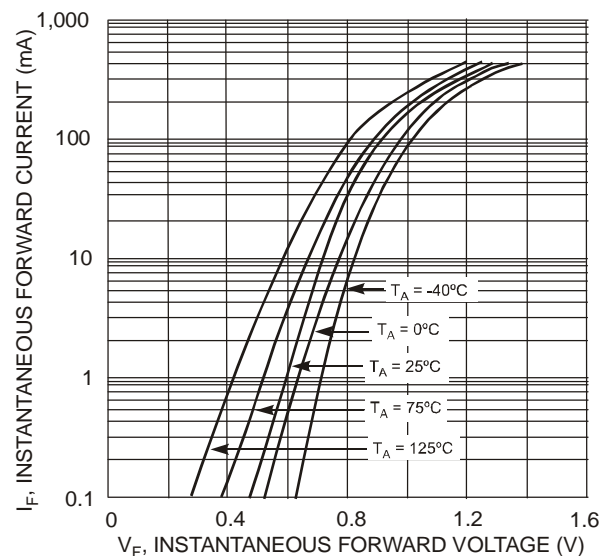


Fig. 2 Typical Forward Characteristics

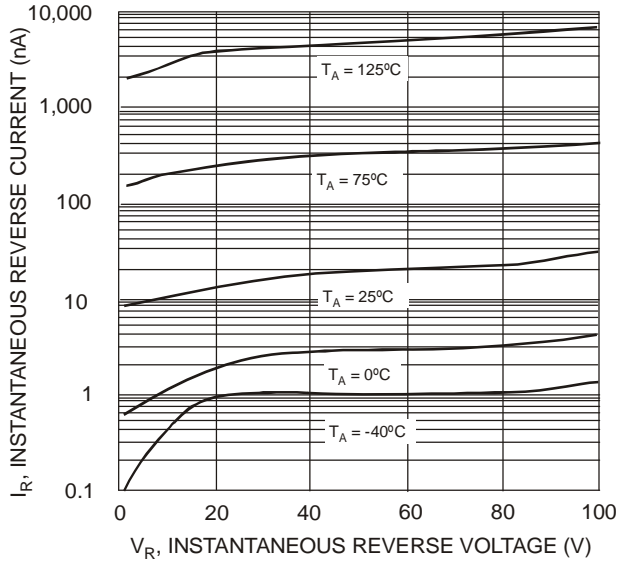


Fig. 3 Typical Reverse Characteristics

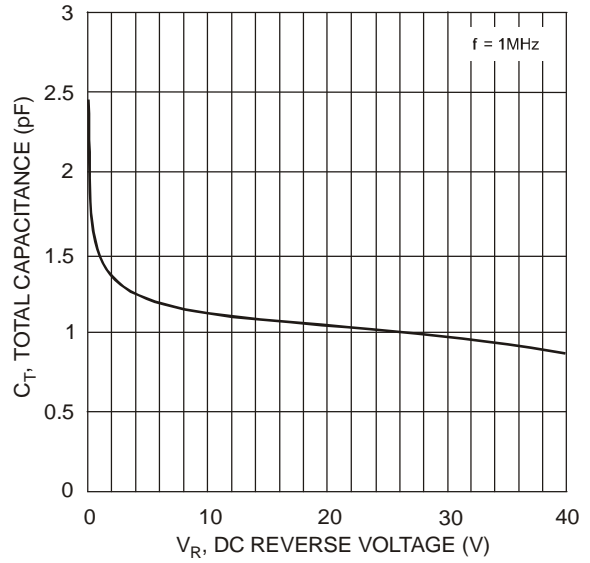


Fig. 4 Total Capacitance vs. Reverse Voltage

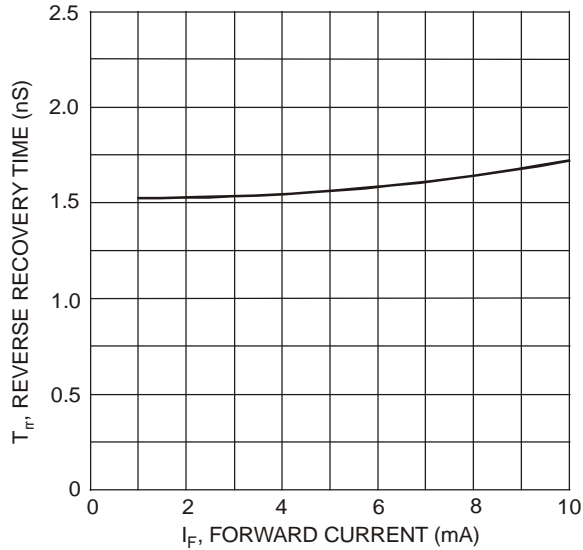


Fig. 5 Reverse Recovery Time vs. Forward Current

Package Outline Dimensions

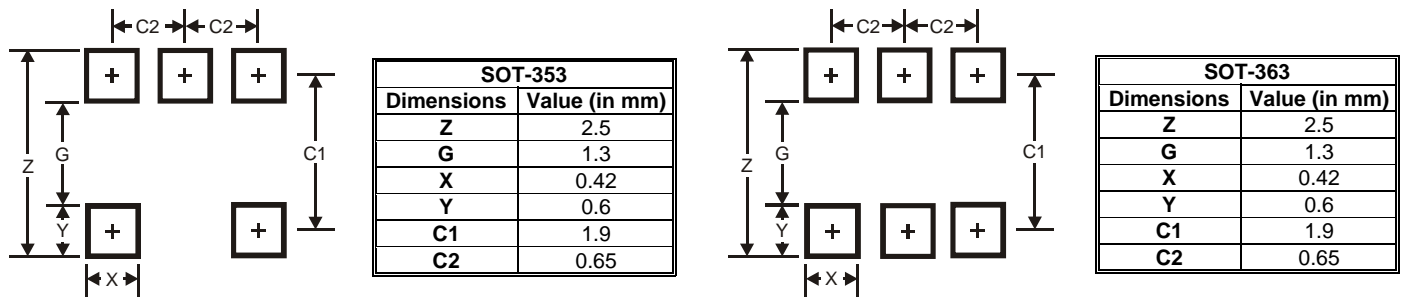
The figure includes mechanical drawings of the SOT-353 and SOT-363 packages from top, side, and perspective views, showing dimensions A through M and angle α . Below the drawings are two tables of dimensions in mm.

SOT-353		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Typ	
F	0.40	0.45
H	1.80	2.20
J	0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.22
α	0°	8°

SOT-363		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Typ	
F	0.40	0.45
H	1.80	2.20
J	0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.22
α	0°	8°

All Dimensions in mm

Suggested Pad Layout



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